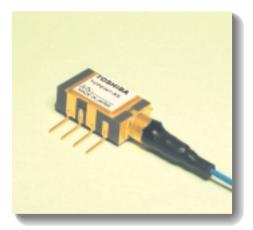
March 2001

# Mar **Optical Communication Devices** 2.5 Gb/s Optical Receiver

**TOPD347-RX Series** 



## **APPLICATION**

SONET / SDH (OC-48 / STM-16) applications

## FEATURES

- PIN-PD and TIA
- Mini-DIL package
- Differential data output
- Sensitivity: -23.5 dBm (Typ. @ BER = 1 x 10<sup>-10</sup>)
- Overload: -3 dBm (Typ. @ BER = 1 x 10<sup>-10</sup>)
- Wavelength: 1.3/1.55 μm
- Operating case temperature range: -20 to +85 °C
- Package size: 7.4 (W) x 13.2 (D) x 4.6 (H) mm

## **TOPD347-RX Series**

## **ABSOLUTE MAXIMUM RATINGS**

| Item                                    | Symbol      | Rating       | Unit   |
|-----------------------------------------|-------------|--------------|--------|
| Storage temperature                     | Tstg        | -40 to +85   | °C     |
| Operating case temperature              | Тс          | -20 to +85   | °C     |
| PD forward current                      | lf          | 10           | mA     |
| PD reverse current                      | lr          | 1            | mA     |
| PD reverse voltage                      | Vpd         | 20           | V      |
| Positive supply voltage (+5 V / +3.3 V) | Vdd         | 0 to +6 / +4 | V      |
| Soldering temperature / time            | Tsol / tsol | 260 / 5      | °C / s |

## ELECTRICAL AND OPTICAL CHARACTERISTICS (Tc = 25 °C, Vpd = +5 V, Vdd = +5 V or +3.3 V)

| Item                    | Min | Тур.  | Max  | Unit | Note |
|-------------------------|-----|-------|------|------|------|
| Positive supply current | —   | 50    | —    | mA   |      |
| Sensitivity             | _   | -23.5 | —    | dBm  | (1)  |
| Overload                | _   | -3    | —    | dBm  | (1)  |
| Bandwidth (–3 dB)       | 1.4 | 1.8   | _    | GHz  | (2)  |
| Logic sense             |     |       |      |      | (3)  |
| Optical return loss     | _   | _     | -27  | dB   | (4)  |
| Output signal amplitude | 15  | _     | 1000 | mVpp | (5)  |
| Electrical return Loss  | 10  | _     | _    | dB   | (6)  |
|                         | 9   | —     | —    | dB   | (7)  |

Notes (1) 2.48832 Gb/s, NRZ, PRBS 2<sup>31</sup>–1, BER = 1 x 10<sup>-10</sup>,  $\lambda$  = 1.55  $\mu m$ 

(2) 0 dBm > Pf > -20 dBm

(3) DATA OUT (+), Light ON = Vout Logic HIGH

DATA OUT (-), Light ON = Vout Logic LOW

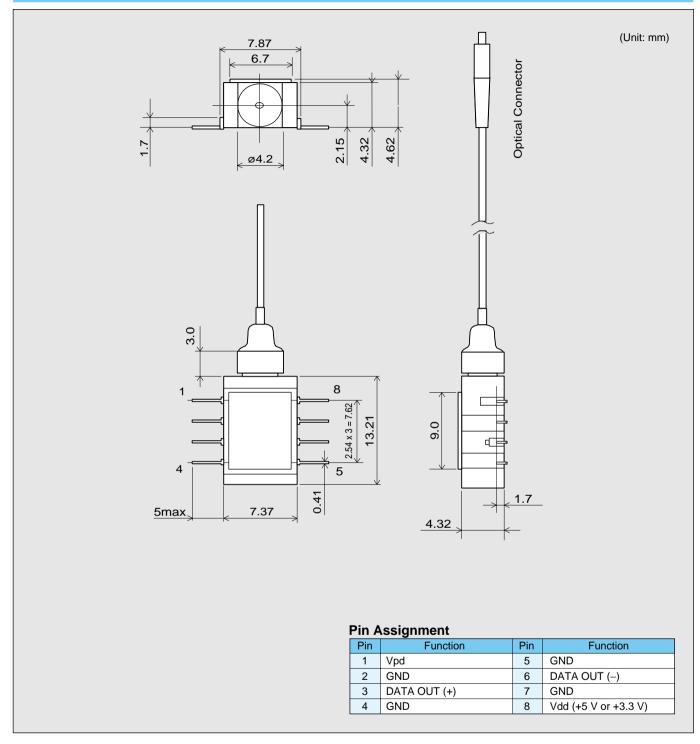
(4) λ = 1.3/1.55 μm

(5) 0 dBm > Pf > -20 dBm

(6) 0.13 GHz < F < 1.75 GHz

(7) 1.75 GHz < F < 2.5 GHz

## DIMENSIONAL OUTLINE AND PIN ASSIGNMENT



### PRECAUTIONS

(a) Power supply: Transient electric spike may cause a damage to the photodiode or IC chips.
A surge-free power supply and a slow starter circuit should be used.
To avoid causing an electrical surge, pins should not be connected or disconnected on the test fixture before turning the power off.

(b) The product should be grounded for obtaininng the performance.

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